

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Heinz Hofmann, et al.

Examiner: Unassigned

Serial No.: To be assigned

Art Unit: Unassigned

Filed: Herewith

Docket: 15669Z

For: INSENSITIVE EXPLOSIVE
MOLDING POWDER, PASTE PROCESS

Dated: September 26, 2003

Commissioner for Patents
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with 37 C.F.R. §§ 1.97 and 1.98, it is requested that the following references, which are also listed on the attached Form PTO-1449, be made of record in the above-identified case.

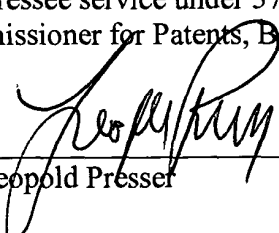
1. German Patent No. DE-43 24 739 C1 dated September 8, 1994, issued to Kleinschmidt, et al., together with English language abstract;
2. European Patent No. EPO 0 816 307 B1 dated January 7, 1998, issued to Lefumeux, et al., together with English language abstract;

CERTIFICATE OF MAILING BY EXPRESS MAIL

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I hereby certify that this correspondence is being deposited with the United States Postal Service Express Mail Post Office to Addressee service under 37 C.F.R. §1.10 on the date indicated above and is addressed to the Commissioner for Patents, Box 1450, Alexandria, VA 22313-1450.

Dated: September 26, 2003



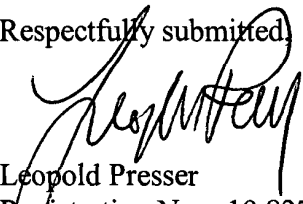
Leopold Presser

3. German Patent No. DE 3804397 C1 dated September 7, 1989, issued to Kleinschmidt, et al., together with an English language abstract;
4. U.S. Patent No. 5,458,706 dated October 17, 1995 issued to Finck, et al.;
5. U.S. Patent No. 5,067,996 dated November 1991 issued to Lundstrom et al.;
6. U.S. Patent No. 5,547,526 dated August 1996 issued to Wanniger et al.;
7. U.S. Patent No. 6,485,587 dated November 2002 issued to Han et al.;
8. U.S. Patent No. 5,316,600 dated May 1994 issued to Chan et al.;
9. U.S. Patent No. 5,565,150 dated October 1996 issued to Dillehay et al.;
10. U.S. Patent No. 5,567,912 dated October 1996 issued to Manning et al.;
11. U.S. Patent No. 5,750,921 dated May 1998 issued to Chan et al.;
12. U.S. Patent No. 5,932,835 dated August 1999 issued to Woodall et al.;
- and
13. U.S. Patent No. 6,217,799 dated April 2001 issued to Lee et al.

A copy of DE-43 24 739 C1, with English language abstract, EPO 0 816 307 B1, with English language abstract, and DE 3804397 C1, with English language abstract, is enclosed. As indicated in PRE-OG Notice dated July 11, 2003, a copy of each U.S. Patent is no longer required, therefore applicants have not enclosed a copy of the U.S. Patents listed above in this Information Disclosure Statement.

Consideration of this Information Disclosure Statement is respectfully
requested.

Respectfully submitted,



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Enclosure PTO 1449

INFORMATION DISCLOSURE CITATION <i>(Use several sheets if necessary)</i>				Docket Number (Optional) 15669Z		Application Number To be assigned		
				Applicant(s) Heinz Hofmann, et al.				
				Filing Date Herewith		Group Art Unit unassigned		
U.S. PATENT DOCUMENTS								
*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
		5,458,706	10/17/95	Finck, et al				
		5,067,996	11/1991	Lundstrom et al.				
		5,547,526	8/1996	Wanniger et al.				
		6,485,587	11/2002	Han et al.				
		5,316,600	5/1994	Chan et al.				
		5,565,150	10/1996	Dillehay et al.				
		5,567,912	10/1996	Manning et al.				
		5,750,921	5/1998	Chan et al.				
		5,932,835	8/1999	Woodall et al.				
		6,217,799	4/2001	Lee et al.				
FOREIGN PATENT DOCUMENTS								
	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
		DE 43 24 739 C1	9/8/94	Germany				
		EPO 0 816 307 B1	1/7/98	Europe				
		DE 38 04 397 C1	9/7/89	Germany				
OTHER DOCUMENTS <i>(Including Author, Title, Date, Pertinent Pages, Etc.)</i>								
EXAMINER				DATE CONSIDERED				
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								